Carrier scattering by workfunction fluctuations and interface dipoles in high-$\kappa$/metal gate stacks

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Abstract—The introduction of a high-$\kappa$/metal gate stack in metal-oxide-Semiconductor field-effect transistors can cause a significant degradation of the mobility, especially at weak inversion densities. This degradation is commonly ascribed to remote Coulomb scattering (RCS, i.e., charges trapped at the SiO$_2$/HfO$_2$ interface). However, very large densities of RCS charges are usually needed to reproduce the experimental data. In this work, we explore alternative scattering mechanisms by quantum calculations of the carrier mobilities. We consider, in particular, metal grain workfunction fluctuations and local dipoles at the SiO$_2$/HfO$_2$ interface. Similarly to RCS, both scattering mechanisms are found to reduce the carrier mobility significantly at low carrier densities. However, the mobility exhibits a different dependence on the thickness of high-$\kappa$ layer, which provides a way to identify the dominant mechanism.

I. INTRODUCTION

High-$\kappa$/metal gate stacks have been introduced in Metal-Oxide-Semiconductor Field-Effect-Transistors (MOSFETs) in order to keep a tight electrostatic control over short channels while limiting gate leakage currents. However, they are responsible for a significant degradation of the carrier mobilities, especially at weak inversion densities. A number of scattering mechanisms have been put forward to explain this degradation, such as remote Coulomb scattering (RCS, i.e., charges trapped at the SiO$_2$/HfO$_2$ interface). However, the density of RCS charges needed to reproduce the experimental mobilities is usually very high (a few $10^{11}$ cm$^{-2}$) [1], [2], and shall result in significant threshold voltage shift and variability. Therefore, we explore in this work alternative mechanisms, such as granularity in the metal gate and local dipoles at the SiO$_2$/HfO$_2$ interface, using quantum calculations in the non-equilibrium Green’s Functions (NEGF) framework. NEGF allows a straightforward, explicit introduction of such disorders in the geometry of the devices.

II. METHODOLOGY AND DEVICES

The simulated devices are (100) fully-depleted silicon-on-insulator (FDSOI) transistors with film thickness $t_{Si} = 4$ nm and width $W = 60$ nm. The transport properties are computed in the non-equilibrium Green’s function (NEGF) framework. We focus on electrons, described within the effective-mass approximation. The NEGF equations are solved self-consistently in a fully coupled mode space approach [4]. In our calculations, we take into account carrier-phonon scattering as well as scattering by workfunction fluctuations in the metal gate, or scattering by charges/dipoles at the SiO$_2$/HfO$_2$ interface. A detailed review of the methodology can be found in Ref. [5]. The carrier mobilities are computed from a quasi-Fermi level analysis [6] in a 60 nm long channel.

III. RESULTS AND DISCUSSION

A. Scattering by metal-gate workfunction fluctuations

The gate metal is usually granular, and the size and orientation of the grains depend on device processing. The workfunction of the grains may vary with their orientation, which results in local variations of the workfunction and gate potential [7], [8]. A lot of efforts have already been devoted to the assessment of the impact of these fluctuations [3], [9]–[12]. However, the vast majority of these studies focused on the effects of the workfunction fluctuations on the intrinsic device variability (i.e., threshold voltage, on and off-current, etc...).
No attention has been paid to the impact of these fluctuations on the carrier mobility in long channels.

We focus here on Titanium Nitride (TiN), one of most technologically relevant metal gate materials. It is known to form grains with size in the 2 nm to 20 nm range. Depending on the grain orientation, the work function may vary by $\Delta WF = \pm 0.1$ eV [3] from one grain to the other. An example of grain pattern (local workfunction fluctuations) is shown in Fig. 1. The average size of the grains is $D = 5$ nm. To generate such a pattern, we choose $N = WL/(\pi D^2)$ random seed points at the metal/HfO$_2$ interface and define the grain associated with each seed as the set of points closer to that seed than to any other. The workfunction of each grain is then either $WF = 4.6$ eV with 60% chance and 4.4 eV with 40% chance.

We first examine how the electron mobility depends on the grain size. The total phonons (PH) + metal grains (MG) mobility $\mu_{PH+MG}$ is plotted in Fig. 2. There is a significant degradation of the mobility at low carrier densities. Metal grain scattering therefore behaves, in this respect, as RCS. The mobility gets worse with increasing grain size at least up to $D = 10$ nm.

In order to find an unique signature of MG scattering, we have analyzed how the phonon + MG mobility depends on the thickness of the SiO$_2$ ($t_{ox}$) and HfO$_2$ ($t_{HfO2}$) layers and compared with the phonon + RCS mobility. The results are plotted in Fig. 3. We find that the phonon + MG mobility increases with increasing $t_{ox}$. This is also true for the phonon + RCS mobility [13]: the disorder moves away from the channel in both cases. However, the phonon + MG mobility increases with increasing $t_{HfO2}$, while the phonon + RCS mobility decreases [13]. Indeed, the effects of workfunction fluctuations are washed out when the gate is moved away from the channel, while the effects of RCS charges at the SiO$_2$/HfO$_2$ interface are enhanced because they are not screened as efficiently by the gate.

We can quantify these trends on the partial RCS and MG mobilities. They are defined from Matthiessen’s rule as $\mu_M^{-1} = \mu_{PH+M}^{-1} - \mu_{PH}^{-1}$, where “M” is a given scattering mechanism (MG or RCS), and phonons (PH) are taken as a reference [5]. The dependence of the partial RCS and MG mobilities on $t_{ox}$ and $t_{HfO2}$ are plotted in Fig. 4, at low carrier density $n = 2 \times 10^{12}$ cm$^{-2}$. The RCS mobility decreases almost exponentially with decreasing $t_{ox}$, and so does the MG mobility (Fig. 4). Yet the MG mobility increases with increasing $t_{HfO2}$ (as the gate is moved away from the channel), while the RCS mobility decreases (as the RCS charges are less screened by the gate).

B. Scattering by interface dipoles

In addition to MG scattering, we have analyzed scattering by dipoles (instead of charges) at the SiO$_2$/HfO$_2$ interface. These dips are worth considered that the incorporation of metal dopants in HfO$_2$ to modulate the threshold voltage for example [14]. The dips are perpendicular to the interface and are treated in the same way as RCS in the NEGF solver [5]. In the following, the density of interface dipoles is $n_{Dip} = 10^{13}$ cm$^{-2}$ and the magnitude of each dipole is $p = 0.5 \text{ e } \cdot \text{ nm}$. 
Fig. 4. Partial RCS, MG and DP mobilities as a function of $t_{ox}$ ($t_{HfO_2} = 2$ nm, upper panel) and $t_{HfO_2}$ ($t_{ox} = 1$ nm, lower panel), at low carrier density $n = 2 \times 10^{12}$ cm$^{-2}$. For MG, the average grain size is $D = 5$ nm, while the density of RCS (or DP) charges is $n = 10^{13}$ cm$^{-2}$.

The computed phonons (PH) + interface dipoles (DP) mobility $\mu_{PH+DP}$ is plotted as a function of the inversion density in Fig. 5. Similarly to the MG and RCS scattering, interface dipoles also cause a significant degradation of the mobility at low carrier densities [1]. The total PH + DP mobility increases with increasing either $t_{ox}$ or $t_{HfO_2}$ (see Fig. 4) – though the mobility shows a much weaker dependence on $t_{HfO_2}$ than on $t_{ox}$. Namely, the partial DP mobility $\mu_{DP}$ increases exponentially with increasing $t_{ox}$, as for MG and RCS scattering (see Fig. 4). In contrast with RCS however, it weakly increases with increasing $t_{HfO_2}$. Indeed, while the field created by a single charge at the SiO$_2$/HfO$_2$ interface is better screened when decreasing $t_{HfO_2}$ (because the image charge in the metal is opposite), the field created by a single dipole is enhanced (because the image dipole is the same sign). The partial DP mobility is expected to behave as $1/(n_{DP} \times p^2)$.

C. Discussion

The scattering by RCS charges, dipoles at the SiO$_2$/HfO$_2$ interface or metal gate workfunction fluctuations show different dependences on $t_{HfO_2}$. These mechanisms are not exclusive one from the other, so that the actual mobility in a device is certainly a combination of RCS, MG and DP contributions.
Yet a detailed analysis of the dependence of the mobility on $t_{ox}$ and $t_{HfO_2}$ might help to identify the dominant mechanism.

Note that workfunction fluctuations have little impact on the threshold voltage in long channels as they average to $\sim 0$. Both charges and dipoles at the SiO$_2$/HfO$_2$ interface result in significant threshold voltage shifts unless they also average to zero (i.e., distribution of positively and negatively charged traps at the interface, or distribution of up and down dipoles). Fluctuations in the band alignment at the SiO$_2$/HfO$_2$ interface due to non-homogeneities at this interface [15] could actually be mimicked by a distribution of dipoles at the interface with zero average.

IV. CONCLUSIONS

In the Non-equilibrium Green’s Functions framework, we have studied carrier scattering by metal grain (MG) workfunction fluctuations and by dipoles (DP) at the SiO$_2$/HfO$_2$ interface in high-$\kappa$/metal gate stacks. Both workfunction fluctuations and interface dipoles result in a significant degradation of the mobility, especially at low carrier densities. In this respect, they behave the same as Remote Coulomb Scattering (RCS) by charges at the SiO$_2$/HfO$_2$ interface. However, the RCS mobility decreases with increasing HfO$_2$ thickness, while the MG mobility significantly increases and the DP mobility only weakly increases. These different dependences might provide a way to identify the dominant scattering mechanism experimentally.

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REFERENCES


